

Prior Foreign Application(s):

| | | | Priority Claimed | |
|-----------------------|--------------|-------------------------|------------------|-------------|
| | | | Yes | No |
| <u>11-50897(PAT.)</u> | <u>Japan</u> | <u>26/February/1999</u> | <u>X</u> | <u> </u> |
| (Number) | (Country) | (Day/Month/Year Filed) | | |

I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.

(Application Number)

(Filing Date)

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Appl. Serial No.)

(Filing Date)

(Status) (patented, pending,
abandoned)

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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Randolph A. Smith 32,548

Please address all correspondence and communications to:

Randolph A. Smith
Smith Patent Office
1901 Pennsylvania Ave., N.W.,
Suite 200,
Washington, D.C. 20006
Tel: (202) 530-5900
Fax: (202) 530 5902

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1-00
Full name of sole or first inventor Nobuyoshi NAMBU
Inventor's Signature Nobuyoshi Nambu
Date August 16, 2001
Residence Yokkaichi-shi, Mie, Japan JPX
Citizenship Japan
Post Office Address c/o Yokkaichi Works in Chubu Chelest Co., Ltd.,
3-3, Hinagahigashi 3-chome, Yokkaichi-shi,
Mie 510-0886 Japan

2-w

Full name of second inventor Osamu ITO

Inventor's Signature Osamu Ito

Date August 16, 2001

Residence Yokkaichi-shi, Mie, Japan

JPX

Citizenship Japan

Post Office Address c/o Yokkaichi Works in Chubu Celest Co., Ltd.,

3-3, Hinagahigashi 3-chome, Yokkaichi-shi,

Mie 510-0886 Japan

3-60

Full name of third inventor Shiho HORIUCHI

Inventor's Signature Shiho Horinuchi

Date August 14, 2001

Residence Osaka-shi, Osaka, Japan JPX

Citizenship Japan

Post Office Address 28-19-1208, Mattaomiya 4-chome, Tsurumi-ku,

Osaka-shi, Osaka 538-0031 Japan

4-00

Full name of fourth inventor Takao DOI

Inventor's Signature Takao Doi

Date August 16, 2001

Residence Yokkaichi-shi, Mie, Japan JPX

Citizenship Japan

Post Office Address c/o Yokkaichi Works in Chubu Celest Co., Ltd.,

3-3, Hinagahigashi 3-chome, Yokkaichi-shi,

Mie 510-0886 Japan